Medium Voltage Multilayer Ceramic Chip Capacitors

1. INTRODUCTION

Medium voltage multilayer ceramic chip capacitors are manufactured by using green materials without lead and cadmium. These capacitors feature series connection of multi-layer capacitor units in a MLCC to realize high voltage performance. Reliable performances are built-in through exact formulation of dielectric powders, preparation of conductive paste, advanced automatic manufacturing, and strict quality control to assure excellent control in dielectric thickness, electrode integrity, and electrode-to-termination continuity.

2. FEATURES

a. High Voltage in a given case size.
b. High reliability and stability.
c. RoHS compliant.

3. APPLICATIONS

a. DC to DC converter.
b. High voltage coupling/DC blocking.
c. Back-Lighting inverters.
d. For bypassing.

4.HOW TO ORDER

COG	1206	100	J	2A	N	R
DIELECTRIC	SIZE	CAPACITANCE	TOLERANCE	RATED VOLTAGE	TERMINATION CODE	PACKING CODE
NPO=COG X7R = BX Y5V=Y5V	0402 0603 0805 1206 1210 1812 1825 2220 2225	1PF = 1R0 1.5PF = 1R5 2.2PF =2R2 100PF=101 120PF=121 10nF=103 100nF= 104	A=±0.05PF B=±0.1PF C=±0.25PF D=±0.5PF F=±1% G=±2% J=±5% K=±10% M=±20%	2A=100V 2D=200V 2E=250V 2H=500V 2J =630V	N=NICKEL BARRIER	B=BULK R=TAPED ON REEL

5. EXTERNAL DIMENSIONS

Size Inch (mm)	L (mm)	W (mm)	Tmax (mm)	M_B min (mm)
0402 (1005)	1.00±0.05	0.50±0.05	0.55	0.15
0603 (1608)	1.60±0.10	0.80±0.10	0.95	0.20
	1.60+0.15/-0.10	0.80±0.15		
0805 (2012)	2.00±0.20	1.25±0.20	1.45	0.30
1206 (3216)	3.20±0.20	1.60±0.20	1.90	0.30
1210 (3225)	3.20±0.40	2.50±0.30	2.80	0.30
1808 (4520)	4.50±0.40	2.00±0.20	1.80	0.26
1812 (4532)	4.50±0.40	3.20±0.30	2.80	0.26
1825 (4563)	4.60±0.30	6.30±0.40	3.00	0.26
2220 (5750)	5.70±0.40	5.00±0.40	3.00	0.30
2225 (5763)	5.70±0.40	6.30±0.40	3.00	0.30

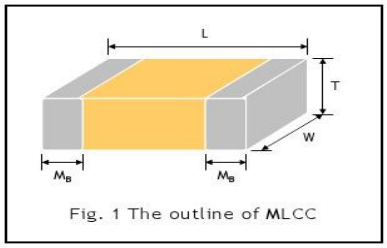


Fig. 1 The outline of MLCC

6.GENERAL ELECTRICAL DATA

Dielectric	C0G(NPO)	X7R	Y5V
Size	0402, 0603, 0805, 1206, 1210, 1808 ,1812, 1825, 2220, 2225	0603, 0805, 1206, 1210,1808, 1812, 1825, 2220, 2225	0805, 1206, 1210, 1812
Capacitance range*	0.5pF ~ 120nF	100pF ~ 1000nF	10nF to 820nF
Capacitance tolerance	Cap. Rang / Tolerance Spec. Cap≤5pF: B (±0.1pF), C (±0.25pF) 5pF<Cap<10pF: C (±0.25pF), D (±0.5pF) 10pF≤Cap: F (±1%), G (±2%), J (±5%),K (±10%)	J (±5%), K (±10%), M (±20%)	Z (-20/+80%)
Rated voltage (WVDC)	100V, 200V, 250V, 500V, 630V	100V, 200V,250V, 500V, 630V	100V, 200V, 250V
Tan δ	Cap. Rang / Q Spec. Cap<30pF: Q≥400+20C Cap≥30pF: Q≥1000	≤ 2.5%	≤5%
Capacitance & Tan δ Test Condition	Measured at the condition of 30~70% related humidity.		
	for 25℃ at ambient temperature	Preconditioning for Class II MLCC: Perform a heat treatment at 150±10℃ for 1 hour, then leave in ambient conditio n for 24±2 hours before measurement.	
	Cap. Rang / Test Condition Cap≤1000pF: 1.0±0.2Vrms, 1.0MHz±10% Cap>1000pF: 1.0±0.2Vrms, 1.0kHz±10%	1.0±0.2Vrms, 1.0kHz±10%, at 25℃ ambient temperature.	1.0±0.2Vrms,1.0kHz±10 %, at 20℃ ambient temperature.
Insulation resistance at Ur	≥100GΩ or R•C≥ 500Ω-F whichever is smaller	≥10GΩ or R•C≥100Ω-F whichever is smaller	
Operating temperature	-55 to +125℃		-25 to +85℃
Capacitance characteristic	±30ppm / ℃	±15%	+30/-80%
Termination	Cu (or Ag)/Ni/Sn (lead-free termination)		

* Measured at the condition of 30~70% related humidity.
C0G(NPO): Apply 1.0±0.2Vrms, 1.0MHz±10% for Cap≤1000pF and 1.0±0.2Vrms, 1.0kHz±10% for Cap>1000pF, 25℃ at ambient temperature
X7R: Apply 1.0±0.2Vrms, 1.0kHz±10%, at 25℃ ambient temperature.
Y5V: Apply 1.0±0.2Vrms, 1.0kHz±10%, at 20℃ ambient temperature.

**Measured at 500VDC for 60 sec, for U_R>500VDC

7.CAPACITANCE RANGE

7-1. C0G(NPO) Dielectric

DIELECTRIC		C0G(NP0)													
SIZE		0402	0603			0805					1206				
RATED VOLTAGE (VDC)		100	100	200	250	100	200	250	500	630	100	200	250	500	630
Capacitance	0.5pF (0R5)														
	1.0pF (1R0)														
	1.2pF (1R2)														
	1.5pF (1R5)														
	1.8pF (1R8)														
	2.2pF (2R2)														
	2.7pF (2R7)														
	3.3pF (3R3)														
	3.9pF (3R9)														
	4.7pF (4R7)														
	5.6pF (5R6)														
	6.8pF (6R8)														
	8.2pF (8R2)														
	10pF (100)														
	12pF (120)														
	15pF (150)														
	18pF (180)														
	22pF (220)														
	27pF (270)														
	33pF (330)														
	39pF (390)														
	47pF (470)														
	56pF (560)														
	68pF (680)														
	82pF (820)														
	100pF (101)														
	120pF (121)														
	150pF (151)														
	180pF (181)														
	220pF (221)														
	270pF (271)														
	330pF (331)														
	390pF (391)														
	470pF (471)														
	560pF (561)														
	680pF (681)														
	820pF (821)														
	1,000pF (102)														
	1,200pF (122)														
	1,500pF (152)														
	1,800pF (182)														
	2,200pF (222)														
	2,700pF (272)														
	3,300pF (332)														
	3,900pF (392)														
	4,700pF (472)														
	5,600pF (562)														
	6,800pF (682)														
	8,200pF (822)														
	0.010μF (103)														
	0.012μF (123)														
	0.015μF (153)														
	0.018μF (183)														
	0.022μF (223)														

7-1. C0G(NPO) Dielectric

DIELECTRIC		C0G(NPO)												
SIZE		1210					1808			1812				
RATED VOLTAGE (VDC)		100	200	250	500	630	100	200 250	500 630	100	200	250	500	630
Capacitance	1.0pF (1R0)													
	1.2pF (1R2)													
	1.5pF (1R5)													
	1.8pF (1R8)													
	2.2pF (2R2)													
	2.7pF (2R7)													
	3.3pF (3R3)													
	3.9pF (3R9)													
	4.7pF (4R7)													
	5.6pF (5R6)													
	6.8pF (6R8)													
	8.2pF (8R2)													
	10pF (100)													
	12pF (120)													
	15pF (150)													
	18pF (180)													
	22pF (220)													
	27pF (270)													
	33pF (330)													
	39pF (390)													
	47pF (470)													
	56pF (560)													
	68pF (680)													
	82pF (820)													
	100pF (101)													
	120pF (121)													
	150pF (151)													
	180pF (181)													
	220pF (221)													
	270pF (271)													
	330pF (331)													
	390pF (391)													
	470pF (471)													
	560pF (561)													
	680pF (681)													
	820pF (821)													
	1,000pF (102)													
	1,200pF (122)													
	1,500pF (152)													
	1,800pF (182)													
	2,200pF (222)													
	2,700pF (272)													
	3,300pF (332)													
	3,900pF (392)													
	4,700pF (472)													
	5,600pF (562)													
	6,800pF (682)													
	8,200pF (822)													
	0.010μF (103)													
	0.012μF (123)													
	0.015μF (153)													
	0.018μF (183)													
	0.022μF (223)													
	0.027μF (273)													
	0.033μF (333)													
	0.039μF (393)													
	0.047μF (473)													

7-1. C0G(NPO) Dielectric

DIELECTRIC		C0G(NPO)														
SIZE		1825					2220					2225				
RATED VOLTAGE (VDC)		100	200	250	500	630	100	200	250	500	630	100	200	250	500	630
Capacitance	10pF (100)															
	12pF (120)															
	15pF (150)															
	18pF (180)															
	22pF (220)															
	27pF (270)															
	33pF (330)															
	39pF (390)															
	47pF (470)															
	56pF (560)															
	68pF (680)															
	82pF (820)															
	100pF (101)															
	120pF (121)															
	150pF (151)															
	180pF (181)															
	220pF (221)															
	270pF (271)															
	330pF (331)															
	390pF (391)															
	470pF (471)															
	560pF (561)															
	680pF (681)															
	820pF (821)															
	1,000pF (102)															
	1,200pF (122)															
	1,500pF (152)															
	1,800pF (182)															
	2,200pF (222)															
	2,700pF (272)															
	3,300pF (332)															
	3,900pF (392)															
	4,700pF (472)															
	5,600pF (562)															
	6,800pF (682)															
	8,200pF (822)															
	0.010μF (103)															
	0.012μF (123)															
	0.015μF (153)															
	0.018μF (183)															
	0.022μF (223)															
	0.027μF (273)															
	0.033μF (333)															
	0.039μF (393)															
	0.047μF (473)															
	0.056μF (563)															
	0.068μF (683)															
	0.082μF (823)															
	0.10μF (104)															
	0.12μF (124)															

7.2 X7R Dielectric

DIELECTRIC		X7R																	
SIZE		0603			0805					1206					1210				
RATED VOLTAGE		100	200	250	100	200	250	500	630	100	200	250	500	630	100	200	250	500	630
Capacitance	100pF (101)																		
	120pF (121)																		
	150pF (151)																		
	180pF (181)																		
	220pF (221)																		
	270pF (271)																		
	330pF (331)																		
	390pF (391)																		
	470pF (471)																		
	560pF (561)																		
	680pF (681)																		
	820pF (821)																		
	1,000pF (102)																		
	1,200pF (122)																		
	1,500pF (152)																		
	1,800pF (182)																		
	2,200pF (222)																		
	2,700pF (272)																		
	3,300pF (332)																		
	3,900pF (392)																		
	4,700pF (472)																		
	5,600pF (562)																		
	6,800pF (682)																		
	8,200pF (822)																		
	0.010μF (103)																		
	0.012μF (123)																		
	0.015μF (153)																		
	0.018μF (183)																		
	0.022μF (223)																		
	0.027μF (273)																		
	0.033μF (333)																		
	0.039μF (393)																		
	0.047μF (473)																		
	0.056μF (563)																		
	0.068μF (683)																		
	0.082μF (823)																		
	0.10μF (104)																		
	0.12μF (124)																		
	0.15μF (154)																		
	0.18μF (184)																		
	0.22μF (224)																		
	0.27μF (274)																		
	0.33μF (334)																		
	0.39μF (394)																		
	0.47μF (474)																		
	0.56μF (564)																		
	0.68μF (684)																		
	0.82μF (824)																		
	1.0μF (105)																		

7.2 X7R Dielectric

DIELECTRIC		X7R													
SIZE		1808				1812					1825				
RATED VOLTAGE (VDC)		100	200	250	500 630	100	200	250	500	630	100	200	250	500	630
Capacitance	100pF (101)														
	120pF (121)														
	150pF (151)														
	180pF (181)														
	220pF (221)														
	270pF (271)														
	330pF (331)														
	390pF (391)														
	470pF (471)														
	560pF (561)														
	680pF (681)														
	820pF (821)														
	1,000pF (102)														
	1,200pF (122)														
	1,500pF (152)														
	1,800pF (182)														
	2,200pF (222)														
	2,700pF (272)														
	3,300pF (332)														
	3,900pF (392)														
	4,700pF (472)														
	5,600pF (562)														
	6,800pF (682)														
	8,200pF (822)														
	0.010μF (103)														
	0.012μF (123)														
	0.015μF (153)														
	0.018μF (183)														
	0.022μF (223)														
	0.027μF (273)														
	0.033μF (333)														
	0.039μF (393)														
	0.047μF (473)														
	0.056μF (563)														
	0.068μF (683)														
	0.082μF (823)														
	0.10μF (104)														
	0.12μF (124)														
	0.15μF (154)														
	0.18μF (184)														
	0.22μF (224)														
	0.27μF (274)														
	0.33μF (334)														
	0.39μF (394)														
	0.47μF (474)														
	0.56μF (564)														
	0.68μF (684)														
	0.82μF (824)														
	1.0μF (105)														

7.2 X7R Dielectric

DIELECTRIC		X7R									
SIZE		2220					2225				
RATED VOLTAGE		100	200	250	500	630	100	200	250	500	630
Capacitance	100pF (101)										
	120pF (121)										
	150pF (151)										
	180pF (181)										
	220pF (221)										
	270pF (271)										
	330pF (331)										
	390pF (391)										
	470pF (471)										
	560pF (561)										
	680pF (681)										
	820pF (821)										
	1,000pF (102)										
	1,200pF (122)										
	1,500pF (152)										
	1,800pF (182)										
	2,200pF (222)										
	2,700pF (272)										
	3,300pF (332)										
	3,900pF (392)										
	4,700pF (472)										
	5,600pF (562)										
	6,800pF (682)										
	8,200pF (822)										
	0.010μF (103)										
	0.012μF (123)										
	0.015μF (153)										
	0.018μF (183)										
	0.022μF (223)										
	0.027μF (273)										
	0.033μF (333)										
	0.039μF (393)										
	0.047μF (473)										
	0.056μF (563)										
	0.068μF (683)										
	0.082μF (823)										
	0.10μF (104)										
	0.12μF (124)										
	0.15μF (154)										
	0.18μF (184)										
	0.22μF (224)										
	0.27μF (274)										
	0.33μF (334)										
	0.39μF (394)										
	0.47μF (474)										
	0.56μF (564)										
	0.68μF (684)										
	0.82μF (824)										
	1.0μF (105)										

7-3. Y5V Dielectric

DIELECTRIC		Y5V											
SIZE		0805			1206			1210			1812		
RATED VOLTAGE(VDC)		100	200	250	100	200	250	100	200	250	100	200	250
Capacitance	0.010μF (103)												
	0.015μF (153)												
	0.022μF (223)												
	0.033μF (333)												
	0.047μF (473)												
	0.068μF (683)												
	0.10μF (104)												
	0.15μF (154)												
	0.18μF (184)												
	0.22μF (224)												
	0.33μF (334)												
	0.47μF (474)												
	0.68μF (684)												
	1.0μF (105)												

8.PACKAGE DIMENSION AND QUANTITY

Size	Thickness (mm)	Paper tape		Plastic tape	
		7" reel	13" reel	7" reel	13" reel
0402 (1005)	0.50±0.05	10k	50K	-	-
0603 (1608)	0.80±0.07	4k	15k	-	-
	0.80+0.15/-0.10	4k	15k		
0805 (2012)	0.60±0.10	4k	15k	-	-
	0.80±0.10	4k	15k	-	-
	1.25±0.10	-	-	3k	10k
	1.25±0.20	-	-	3k	-
1206 (3216)	0.80±0.10	4k	15k	-	-
	0.95±0.10	-	-	3k	10k
	1.25±0.10	-	-	3k	10k
	1.60±0.20 1.60 +0.30/-0.10	-	-	2k	-
1210 (3225)	0.95±0.10	-	-	3k	10k
	1.25±0.10	-	-	3k	10k
	1.60±0.20	-	-	2k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	1k	-
1808 (4520)	1.60±0.20	-	-	2k	-
1812 (4532)	1.25±0.10	-	-	1k	-
	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	3k
1825 (4563)	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
2220 (5750)	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
2225 (5763)	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-

Unit: pieces

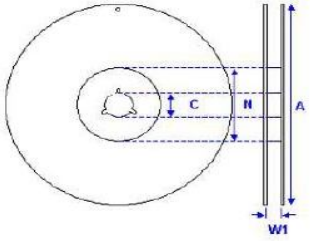


Fig. 4 The dimension of reel

Size	0402, 0603, 0805, 1206, 1210			1808,1812,1825, 2220 ,2225
Reel size	7"	10"	13"	7"
C	13.0+0.5/-0.2	13.0+0.5/-0.2	13.0+0.5/-0.2	13.0+0.5/-0.2
W_1	8.4+1.5/-0	8.4+1.5/-0	8.4+1.5/-0	12.4+2.0/-0
A	178.0±0.10	250.0±1.0	330.0±1.0	178.0±0.10
N	60.0±1.0/-0	100.0±1.0	100±1.0	80.0±1.0

8-1. CARDBOARD TAPE DIMESIONS

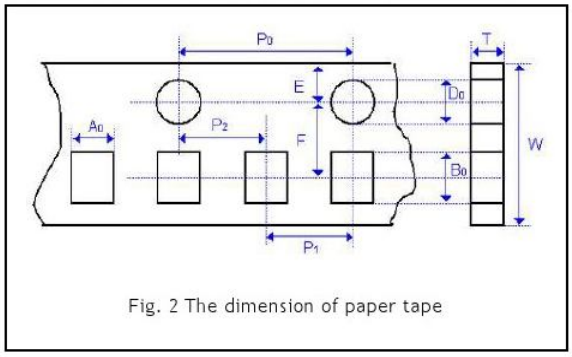


Fig. 2 The dimension of paper tape

8-2. EMBOSSED TAPE DIMENSIONS8-1.

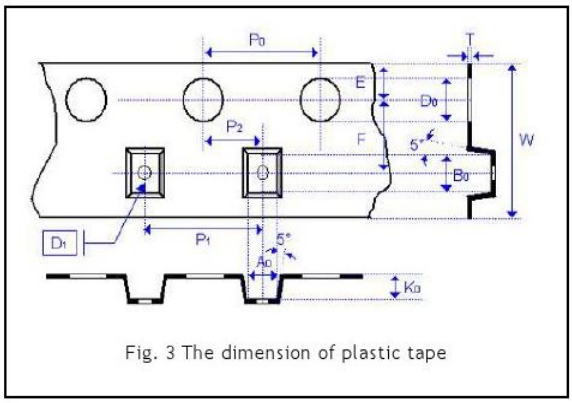


Fig. 3 The dimension of plastic tape

Size	0402	0603		0805		1206			1210	
Chip Thickness	0.50±0.05	0.80±0.07	0.80+0.15/-0.10	0.80±0.10	1.25±0.10 1.25±0.20	0.80±0.10	0.95±0.10 1.25±0.10	1.60±0.20 $1.60^{+0.30}/_{-0.10}$	0.95±0.10 1.25±0.10 1.60±0.20 2.00±0.20	2.50±0.30
A_0	0.62±0.05	1.00+0.05/-0.10	1.02+0.05/-0.10	1.50±0.10	<1.65	2.00±0.10	<2.00	<2.00	<3.05	<3.10
B_0	1.12±0.05	1.80±0.10	1.80±0.10	2.30±0.10	<2.40	3.50±0.10	<3.60	<3.70	<3.80	<4.00
T	0.60±0.05	0.95±0.05	0.97±0.05	0.95±0.05	0.23±0.05	0.95±0.05	0.23±0.05	0.23±0.05	0.23±0.05	0.23±0.05
K_0	-	-	-	-	<2.50	-	<2.50	<2.50	<2.50	<3.50
W	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P_0	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.100	4.00±0.10
$10xP_0$	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20
P_1	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
P_2	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D_0	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.50±0.10/-0	1.55±0.05	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0
D_1	-	-	-	-	1.00±0.10	-	1.00±0.10	1.00±0.10	1.00±0.10	1.00±0.10
E	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10
F	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05

Size	1808		1812		1825		2220		2225	
Chip Thickness	1.25±0.10 1.60±0.20	2.00±0.20	1.25±0.10 1.60±0.20 2.00±0.20	2.50±0.30	1.60±0.20 2.00±0.20	2.50±0.30	1.40±0.15 1.60±0.20 2.00±0.20	2.50±0.30	2.00±0.20	2.50±0.30
A_0	<2.50	<2.50	<3.90	<3.90	<6.80	<6.80	<5.80	<5.80	<6.80	<6.80
B_0	<5.30	<5.30	<5.30	<5.30	<5.30	<5.30	<6.50	<6.50	<6.50	<6.50
T	0.25±0.05	0.25±0.05	0.25±0.05	0.25±0.05	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10
K_0	<2.50	<2.50	<2.50	<3.00	<2.50	<3.10	<2.50	<3.10	<2.50	<3.10
W	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20
P_0	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
$10xP_0$	40.0±0.20	40.0±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20
P_1	4.00±0.10	4.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P_2	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D_0	1.50±0.10/-0	1.50+0.10/-0	1.50+0.10/-0	1.50+0.10/-0	1.50+0.10/-0	1.50+0.10/-0	1.50+0.10/-0	1.50+0.10/-0	1.50+0.10/-0	1.50+0.10/-0
D_1	1.50±0.10	1.50±0.10	1.50±0.10	1.50+/-0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10
E	1.75±0.10	1.75±0.10	1.75±0.10	1.75+/-0.1	1.75±0.1	1.75±0.10	1.75±0.1	1.75±0.10	1.75±0.10	1.75±0.10
F	5.50±0.05	5.50±0.05	5.50±0.05	5.50+/-0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05

9.APPLICATION NOTES

STORAGE

To prevent the damage of solderability of terminations, the following storage conditions are recommended:

Indoors under 5 ~ 40℃ and 20% ~ 70% RH.

No harmful gases containing sulfuric acid, ammonia, hydrogen sulfide or chlorine.

Packaging should not be opened until the capacitors are required for use. If opened, the pack should be re-sealed as soon as is practicable. Taped product should be stored out of direct sunlight, which might promote deterioration in tape or adhesion performance. The capacitors should be used within 6 months and checked the solderability before use.

HANDLING

Chip capacitors are dense, hard, brittle, and abrasive materials. They are liable to suffer mechanical damage, in the form of cracks or chips. Chip Capacitors should be handled with care to avoid contamination or damage. To use vacuum or plastic tweezers to pick up or plastic tweezers is recommended for manual placement. Tape and reeled packages are suitable for automatic pick and placement machine.

PREHEAT

In order to minimize the risk of thermal shock during soldering, a carefully controlled preheat is required. The rate of preheat should not exceed 4℃ per second and the final preheat temperature should be within 100℃ of the soldering temperature for small chips such as 0402, 0603, 0805 and 1206, within 50℃ of the soldering temperature for bigger chips such as 1210, 1808, 1812, 1825, 2220 and 2225, etc.

SOLDERING

Use middy activated rosin RA and RMA fluxes do not use activated flux. The amount of solder in each solder joint should be controlled to prevent the damage of chip capacitors caused by the stress between solder, chips, and substrate.

Hand soldering with temperature-controlled iron not exceeding 30 watts and diameter of tip less than 1.2 mm is recommended, tip of iron should not contact the ceramic body directly, and the temperature of iron should be set to not more than 260℃.

For bigger chips such as 1210, 1808,1812,1825,2220 and 2225, etc. wave soldering and hand soldering are no recommended.

Refer IPC/JEDEC J-STD-020D Method recommended soldering profiles :

Reflow not sooner than 15 minutes and not longer than 4 hrs after removal from the temperature/humidity chamber, subject the sample to 3 cycle of the appropriate reflow conditions as defined as blow Table description.

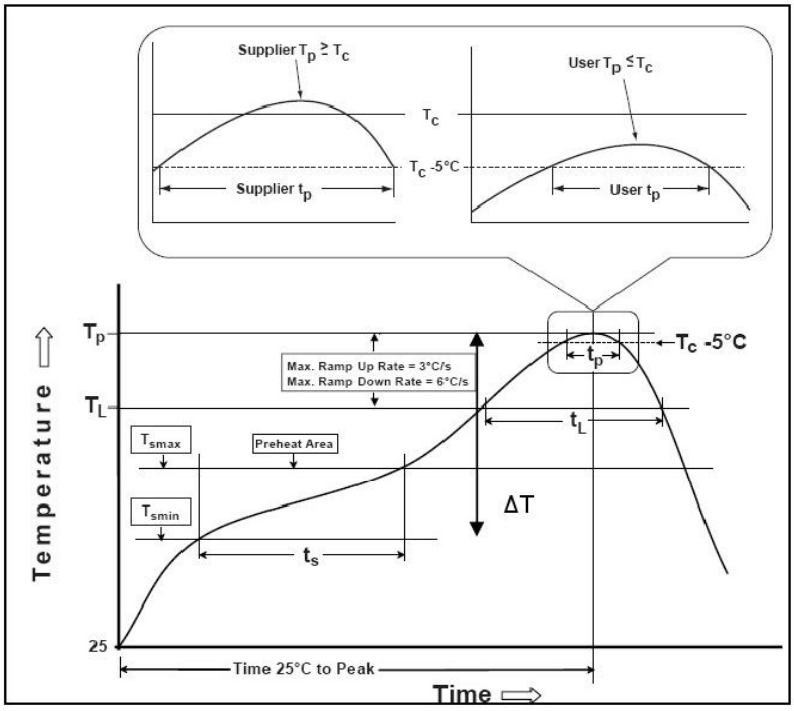
Profile Feature	Pb-Free Assembly
Preheat/Soak Temperature Min.(T_{smin}) Temperature Max.(T_{smax}) Time(t_s) from (T_{smin} to T_{smax})	 150℃ 200℃ 60 to 120 seconds
Ramp-up rate(T_L to T_p)	3℃/second max.
Liquidous temperature(T_L) Time(t_L) maintained above T_L	217℃ 60 to 150 seconds
Peak package body temperature(T_p)	For user Tp must not exceed the Classification temp 260℃ For suppliers Tp must equal or exceed the Classification temp 260℃
Time(T_p)* within 5℃ of the specified classification temperature(T_c)	30* second
Ramp-down rate (T_p to T_L)	6℃/second max.
Time 25℃ to peak temperature 260℃	8 minutes max.

Lead-free : Soldering temperature = 235 to 260℃, depending on product.

Maximum temperature = Minimum temperature (235℃)+ΔT+ Tolerance for oven process and measurement(5 ~ 7℃)

Time at peak temperature = 10sec, Dwell above 217℃ = 90sec, Ramping rate = 3℃/sec(heating) and 6℃/sec(heating).

Classification Reflow Profiles



Chip Size	ΔT
0402,0603,0805,1206	100 ℃
1210, 1808, 1812,1825 2211, 2220, 2225	50 ℃

Soldering	Solder Temp.(T_c)	Soldering Time (t_p)
Reflow	235 – 260 ℃	< 15 sec.
Wave	230 – 260 ℃	< 5 sec.

Note : For example , T_c is 260℃ and time tp is 15sec.
for user : The peak temperature must not exceed 260℃. The time above 255℃ must not exceed 15 seconds.

COOLING

After soldering, cool the chips and the substrate gradually to room temperature. Natural cooling in air is recommended to minimize stress in the solder joint. A cooling rate not exceeding 4℃ per second should be used when forced cooling is necessary.

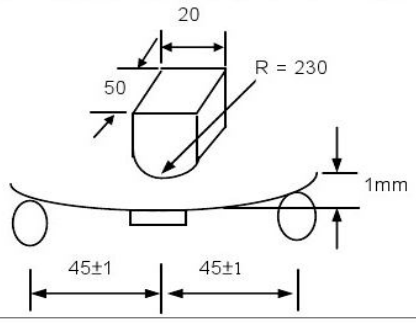
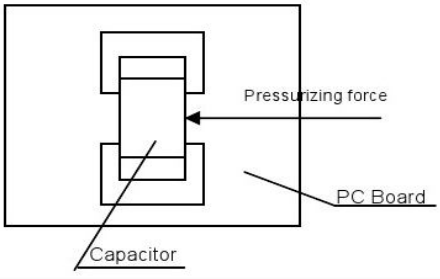
CLEANING

All flux residues must be removed by using suitable electronic-grade vapor-cleaning solvents to eliminate contamination that could cause electrolytic surface corrosion. Good results can be obtained by using ultrasonic cleaning of the solvent. The choice of the proper system is depends upon many factors such as component mix, flux, and solder paste and assembly method. The ability of the cleaning system to remove flux residues and contamination from under the chips is very important.

10.RELIABILITY TEST CONDITIONS AND REQUIREMENTS

<table>
<tr><th>No.</th><th>Item</th><th>Test Condition</th><th>Requirements</th></tr>
<tr><td>1.</td><td>Visual and Dimensions</td><td>---</td><td>* No remarkable defect.
* Dimensions to confirm to individual specification sheet.</td></tr>
<tr><td>2.</td><td>Capacitance</td><td>Class I: C0G(NP0)</td><td>* Shall not exceed the limits given in the detailed spec.</td></tr>
<tr><td>3.</td><td>Q/ D.F. (Dissipation Factor)</td><td>Cap≤1000pF, 1.0±0.2Vrms, 1MHz±10%
Cap>1000pF, 1.0±0.2Vrms, 1KHz±10%
Class II: (X7R, Y5V)
1.0±0.2Vrms, 1kHz±10%</td><td>
<table>
<tr><th>Dielectric</th><th>Rated vol.(V)</th><th>Q/D.F.</th><th>Remark</th></tr>
<tr><td rowspan="2">Class I(NPO)</td><td rowspan="2">≥ 100</td><td>Q≥1000</td><td>Cap≥30pF</td></tr>
<tr><td>Q≥400+20C</td><td>Cap<30pF</td></tr>
<tr><td>Class II(X7R)</td><td>≥ 100</td><td>D.F. < 2.5%</td><td></td></tr>
<tr><td>Class II(Y5V)</td><td>≥ 100</td><td>D.F. < 5.0%</td><td></td></tr>
</table>
</td></tr>
<tr><td>4.</td><td>Temperature Coefficient</td><td>With no electrical load.
<table>
<tr><th>T.C.</th><th>Operating Temp</th></tr>
<tr><td>C0G(NPO)</td><td>-55~125℃ at 25℃</td></tr>
<tr><td>X7R</td><td>-55~125℃ at 25℃</td></tr>
<tr><td>Y5V</td><td>-25~85℃ at 20℃</td></tr>
</table>
</td><td>
<table>
<tr><th>T.C.</th><th>Capacitance Change</th></tr>
<tr><td>C0G(NPO)</td><td>Within ±30ppm/℃</td></tr>
<tr><td>X7R</td><td>Within ±15%</td></tr>
<tr><td>Y5V</td><td>Within +30%/-80%</td></tr>
</table>
</td></tr>
<tr><td>5.</td><td>Insulation Resistance</td><td>
<table>
<tr><th>Rated vol.(V)</th><th>Apply Voltage</th><th>Test Condition</th></tr>
<tr><td>= 100</td><td>1 times of U_R</td><td>Max. 120 sec</td></tr>
<tr><td>>100</td><td>1 times of U_R</td><td>60 sec</td></tr>
<tr><td>> 500</td><td>500VDC</td><td>60 sec</td></tr>
</table>
</td><td>
<table>
<tr><th>Dielectric</th><th>Requirements</th></tr>
<tr><td>Class I</td><td>≥100GΩ or RxC≥ 500Ω-F whichever is smaller</td></tr>
<tr><td>Class II</td><td>≥10GΩ or RxC≥ 100Ω-F whichever is smaller.</td></tr>
</table>
</td></tr>
<tr><td>6.</td><td>Dielectric Strength</td><td>
<table>
<tr><th>Rated vol.(V)</th><th>Condition</th></tr>
<tr><td>≤ 250</td><td>2 times of U_R</td></tr>
<tr><td>500</td><td>1.5 times of U_R</td></tr>
<tr><td>=630</td><td>1.2 times of U_R</td></tr>
</table>
* Duration: 1 to 5 sec.
</td><td>* No evidence of damage or flashover during test.</td></tr>
<tr><td>7.</td><td>Solderability</td><td>* Solder temperature: 235±5℃ for (0603~1210)
* Solder temperature: 245±5℃ for (1808~2225)
* Dipping time: 2±0.5 sec.</td><td>75% min. coverage of all metalized area.</td></tr>
<tr><td>8.</td><td>Resistance to Soldering Heat</td><td>* Solder temperature: 260±5℃
* Dipping time: 10±1 sec
* Preheating: 120 to 150℃ for 1 minute before immerse the capacitor in a eutectic solder.
* Before initial measurement (Class II only): Perform 150+0/-10℃ for 1 hr and then set for 48±4 hrs at room temp.
* Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).</td><td>* No remarkable damage.
<table>
<tr><th>Dielectric</th><th>I.R</th><th>Cap Change</th><th>Q/D.F</th></tr>
<tr><td>Class I(NPO)</td><td>≥ 1GΩ</td><td>Within ±2.5% or ±0.25pF whichever is larger.</td><td rowspan="3">≤ 1.0 × Initial requirement</td></tr>
<tr><td>Class II(X7R)</td><td>≥ 1GΩ</td><td>within ±7.5%</td></tr>
<tr><td>Class II(Y5V)</td><td>≥ 1GΩ</td><td>within ±20%</td></tr>
</table>
* 25% max. leaching on each edge.
</td></tr>
<tr><td>9.</td><td>Temperature Cycle</td><td>* Conduct the five cycles according to the temperatures and time.
<table>
<tr><th>Step</th><th>Temp. (℃)</th><th>Time (min.)</th></tr>
<tr><td>1</td><td>Min. operating emp. +0/-3</td><td>30±3</td></tr>
<tr><td>2</td><td>Room temp.</td><td>2~3</td></tr>
<tr><td>3</td><td>Max. operating temp. +3/-0</td><td>30±3</td></tr>
<tr><td>4</td><td>Room temp.</td><td>2~3</td></tr>
</table>
* Before initial measurement (Class II only): Perform 150+0/-10℃ for 1 hr and then set for 48±4 hrs at room temp.
* Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).</td><td>* No remarkable damage.
<table>
<tr><th>Dielectric</th><th>I.R</th><th>Cap Change</th><th>Q/D.F</th></tr>
<tr><td>Class I(NPO)</td><td rowspan="3">0.25 × initial requirements.</td><td>Within ±2.5% or ±0.25pF whichever is larger.</td><td>≤ 1.0(Q) × Initial requirement</td></tr>
<tr><td>Class II(X7R)</td><td>within ±7.5%</td><td rowspan="2">≤ 1.5(D.F.) × Initial requirement</td></tr>
<tr><td>Class II(Y5V)</td><td>within ±20%</td></tr>
</table>
</td></tr>
<tr><td>10.</td><td>Humidity (Damp Heat) Load</td><td>* Test temp.: 40±2℃
* Humidity: 90~95%RH
* Test time: 500+24/-0 hrs.
* To apply voltage：rated voltage (Max. 500V)
* Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).</td><td>* No remarkable damage.
<table>
<tr><th>Dielectric</th><th>I.R</th><th>Cap Change</th><th colspan="2">Q/D.F</th></tr>
<tr><td rowspan="3">Class I(NPO)</td><td rowspan="3">≥500MΩ or RxC≥ 25Ω-F whichever is smaller.</td><td rowspan="3">within ±5.0% or ±2pF whichever is larger</td><td>Cap ≥30pF</td><td>Q≥350;</td></tr>
<tr><td>10pF ≤ Cap < 30pF</td><td>Q≥275+2.5C</td></tr>
<tr><td>Cap < 10pF</td><td>Q≥200+10C</td></tr>
<tr><td>Class II(X7R)</td><td>within ±15%</td><td colspan="2">D.F. ≤ 2 × Initial requirement</td></tr>
<tr><td>Class II(Y5V)</td><td>within ±30%</td><td colspan="2">D.F. ≤ 7.5%</td></tr>
</table>
</td></tr>
</table>

10.RELIABILITY TEST CONDITIONS AND REQUIREMENTS (Cont.)

<table>
<tr><th>No.</th><th>Item</th><th>Test Condition</th><th>Requirements</th></tr>
<tr><td>11.</td><td>High Temperature Load (Endurance)</td><td>* Test temp.:
NP0, X7R : 125±3℃
Y5V: 85±3℃
<table>
<tr><th>Dielectric</th><th>Rated vol.(V)</th><th>Apply Voltage</th></tr>
<tr><td rowspan="3">NP0, X7R ,Y5V</td><td>≤ 250</td><td>2 times of U_R</td></tr>
<tr><td>250 <V ≤ 500</td><td>1.5 times of U_R</td></tr>
<tr><td>= 630</td><td>1.2 times of U_R</td></tr>
</table>
Exception item(X7R only):
<table>
<tr><th>Rated vol.(V)</th><th>Size</th><th>Cap. Range</th><th>Apply Voltage</th></tr>
<tr><td rowspan="2">100</td><td>0805</td><td>≥ 124</td><td rowspan="5">1.5 times of U_R</td></tr>
<tr><td>1206
1210
1825
2220
2225</td><td>≥ 105</td></tr>
<tr><td rowspan="3">200 & 250</td><td>1210</td><td>> 224</td></tr>
<tr><td>1812</td><td>> 474</td></tr>
<tr><td>1825
2220
2225</td><td>≥ 105</td></tr>
</table>
* Test time: 1000+24/-0 hrs.
* Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).</td><td>* No remarkable damage.
<table>
<tr><th>Dielectric</th><th>I.R</th><th>Cap Change</th><th>Q/D.F</th></tr>
<tr><td>Class I(NPO)</td><td rowspan="3">≥1GΩ or RxC≥ 50Ω-F whichever is smaller.</td><td>within ±3.0% or ±2pF whichever is larger</td><td>D.F. ≤ 2 × Initial requirement</td></tr>
<tr><td>Class II(X7R)</td><td>within ±12.5%</td><td rowspan="2"></td></tr>
<tr><td>Class II(Y5V)</td><td>within ±30%</td></tr>
</table></td></tr>
<tr><td>12.</td><td>Resistance to Flexure of Substrate</td><td>* The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1mm per second until the deflection becomes 1mm.
 
</td><td>* No remarkable damage.
<table>
<tr><th>Dielectric</th><th>Cap Change</th></tr>
<tr><td>Class I(NPO)</td><td>within ±3.0% or ±2pF whichever is larger</td></tr>
<tr><td>Class II(X7R)</td><td>within ±12.5%</td></tr>
<tr><td>Class II(Y5V)</td><td>within ±30%</td></tr>
</table>
(This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test.)</td></tr>
<tr><td>13.</td><td>Adhesive Strength of Termination</td><td>* Capacitors mounted on a substrate. A force of 5N(≤0603) or 10N(> 0603) applied perpendicular to the place of substrate and parallel the line joining the center of terminations for 10±1 second.
 
</td><td>* No remarkable damage or removal of the terminations.</td></tr>
<tr><td>14.</td><td>Vibration Resistance</td><td>* Vibration frequency: 10~55 Hz/min.
* Total amplitude: 1.5mm
* Test time: 6 hrs. (Two hrs each in three mutually perpendicular directions.)</td><td>* No remarkable damage.
* Cap change and Q/D.F.: To meet initial spec.</td></tr>
</table>